

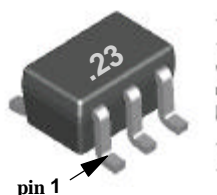
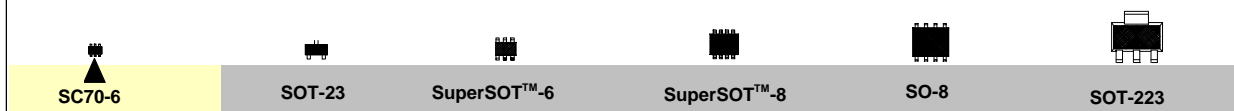
FDG6323L Integrated Load Switch

General Description

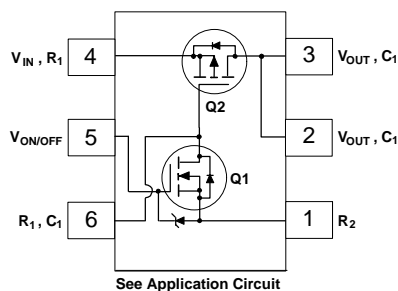
This device is particularly suited for compact power management in portable electronic equipment where 2.5V to 8V input and 0.6A output current capability are needed. This load switch integrates a small N-Channel power MOSFET (Q1) which drives a large P-Channel power MOSFET (Q2) in one tiny SC70-6 package.

Features

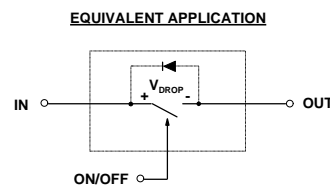
- $V_{\text{DROP}}=0.2\text{V}$ @ $V_{\text{IN}}=5\text{V}$, $I_{\text{L}}=0.36\text{A}$. $R_{\text{(ON)}} = 0.55\Omega$
 $V_{\text{DROP}}=0.2\text{V}$ @ $V_{\text{IN}}=2.5\text{V}$, $I_{\text{L}}=0.27\text{A}$. $R_{\text{(ON)}} = 0.75\Omega$.
- Very small package outline SC70-6.
- Control MOSFET (Q1) includes Zener protection for ESD ruggedness (>6KV Human Body Model).
- High density cell design for extremely low on-resistance.
- Compact industry standard SC70-6 surface mount package.



SC70-6



See Application Circuit



Absolute Maximum Ratings $T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	FDG6323L	Units
V_{IN}	Input Voltage Range	2.5 - 8	V
$V_{\text{ON/OFF}}$	On/Off Voltage Range	1.5 - 8	V
I_{L}	Load Current - Continuous (Note 1)	0.6	A
	- Pulsed (Note 1 & 3)	1.8	
P_{D}	Maximum Power Dissipation (Note 2)	0.3	W
T_J, T_{STG}	Operating and Storage Temperature Range	-55 to 150	$^\circ\text{C}$
ESD	Electrostatic Discharge Rating MIL-STD-883D Human Body Model (100pf/1500Ohm)	6	kV

THERMAL CHARACTERISTICS

$R_{\theta\text{JA}}$	Thermal Resistance, Junction-to-Ambient (Note 2)	415	$^\circ\text{C/W}$
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Electrical Characteristics (T_A = 25°C unless otherwise noted)

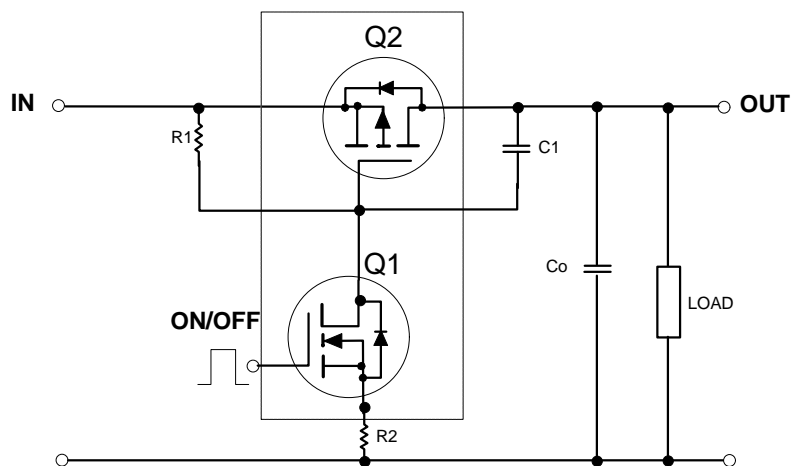
Symbol	Parameter	Conditions	Min	Typ	Max	Units
OFF CHARACTERISTICS						
I _{FL}	Forward Leakage Current	V _{IN} = 8 V, V _{ON/OFF} = 0 V			1	μA
ON CHARACTERISTICS (Note 3)						
V _{DROP}	Conduction Voltage Drop	V _{IN} = 5 V, V _{ON/OFF} = 3.3 V, I _L = 0.36 A		0.14	0.2	V
		V _{IN} = 2.5 V, V _{ON/OFF} = 3.3 V, I _L = 0.27 A		0.15	0.2	
R _(ON)	Q ₂ - Static On-Resistance	V _{GS} = -5 V, I _D = -0.6 A		0.41	0.55	Ω
		V _{GS} = -2.5 V, I _D = -0.5 A		0.58	0.75	
I _L	Load Current	V _{DROP} = 0.2 V, V _{IN} = 5 V, V _{ON/OFF} = 3.3 V	0.36			A
		V _{DROP} = 0.2 V, V _{IN} = 2.5 V, V _{ON/OFF} = 3.3 V	0.27			

Notes:

- Range of V_{in} can be up to 8V, but R₁ and R₂ must be scaled such that V_{GS} of Q₂ does not exceed -8V.
- R_{θJA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins.
R_{θJC} is guaranteed by design while R_{θCA} is determined by the user's board design.
- Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2.0%

FDG6323L Load Switch Application

APPLICATION CIRCUIT



External Component Recommendation

R1 is required to turn Q2 off.
R2 is optional for Slew Rate Control.

For Co ≤ 1μF applications:

First select R2, 100 - 1KΩ, for Slew Rate control.

Then select R1 such that R1/R2 ratio maintains between 10 - 100.

Typical Electrical Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise noted)

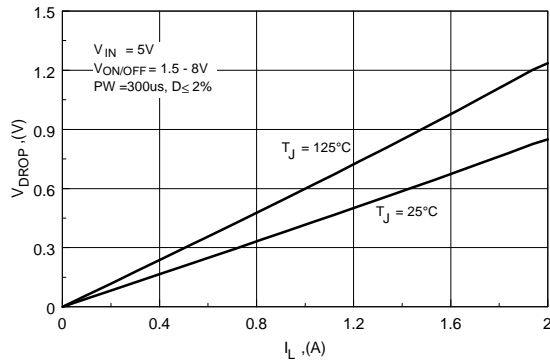


Figure 1. Conduction Voltage Drop Variation with Load Current.

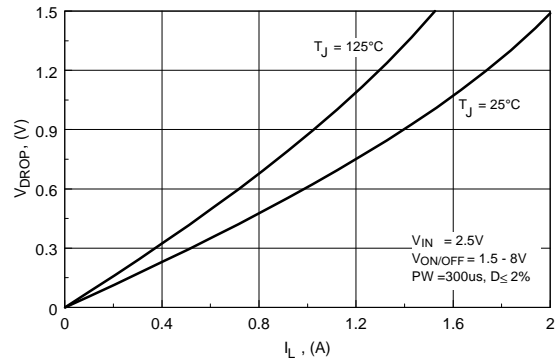


Figure 2. Conduction Voltage Drop Variation with Load Current.

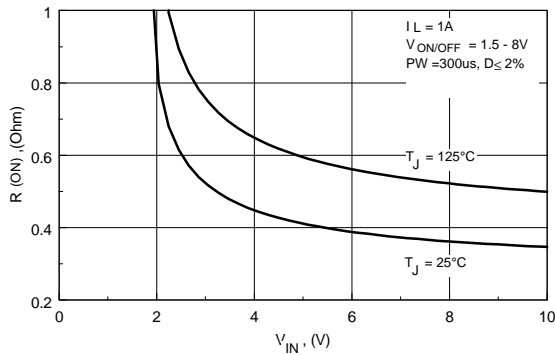


Figure 3. On-Resistance Variation with Input Voltage.

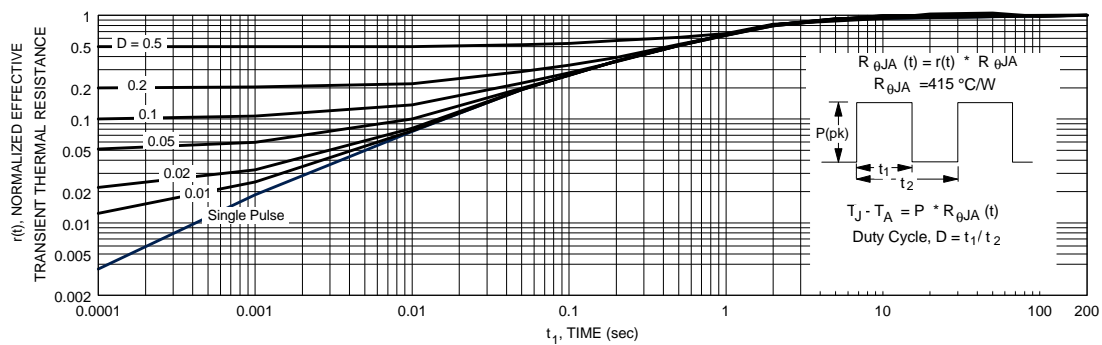


Figure 4. Transient Thermal Response Curve.

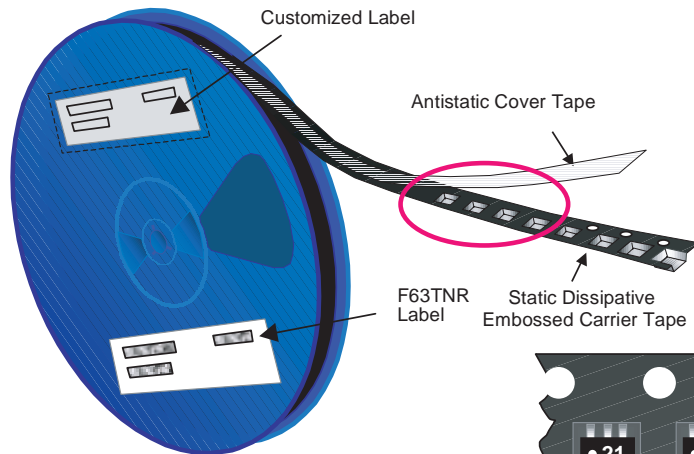
Thermal characterization performed using the conditions described in Note 2.

Transient thermal response will change depending on the circuit board design.

SC70-6 Tape and Reel Data and Package Dimensions

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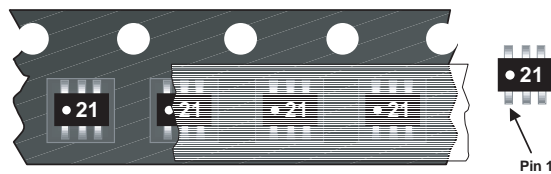
SC70-6 Packaging Configuration: Figure 1.0



Packaging Description:

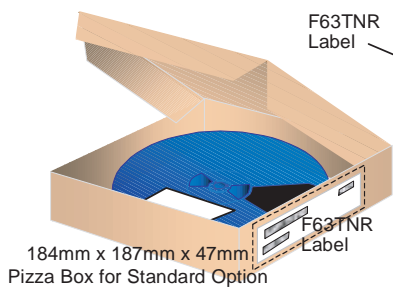
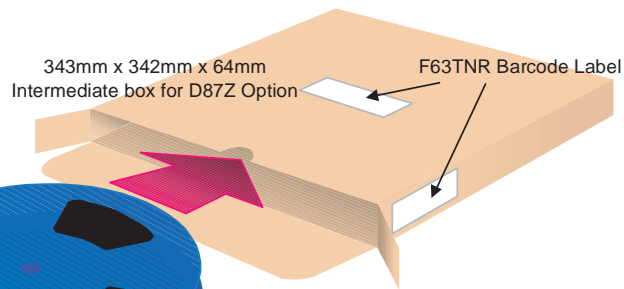
SC70-6 parts are shipped in tape. The carrier tape is made from a dissipative (carbon filled) polycarbonate resin. The cover tape is a multilayer film (Heat Activated Adhesive in nature) primarily composed of polyester film, adhesive layer, sealant, and anti-static sprayed agent. These reeled parts in standard option are shipped with 3,000 units per 7" or 177cm diameter reel. The reels are dark blue in color and is made of polystyrene plastic (anti-static coated). Other option comes in 10,000 units per 13" or 330cm diameter reel. This and some other options are described in the Packaging Information table.

These full reels are individually barcode labeled and placed inside a pizza box (illustrated in figure 1.0) made of recyclable corrugated brown paper with a Fairchild logo printing. One pizza box contains three reels maximum. And these pizza boxes are placed inside a barcode labeled shipping box which comes in different sizes depending on the number of parts shipped.



SC70-6 Unit Orientation

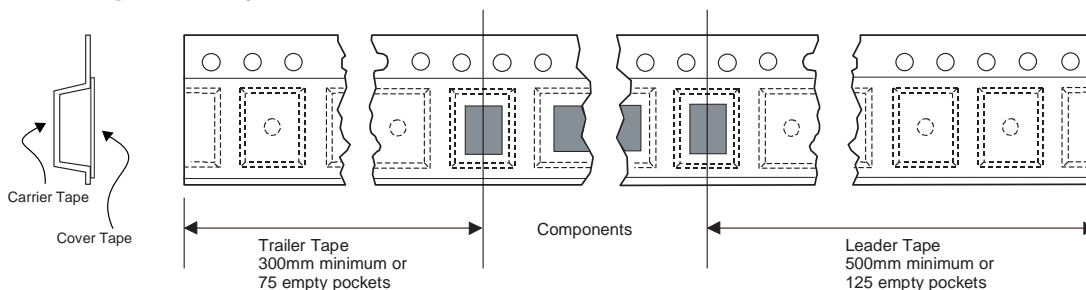
SC70-6 Packaging Information		
Packaging Option	Standard (no flow code)	D87Z
Packaging type	TNR	TNR
Qty per Reel/Tube/Bag	3,000	10,000
Reel Size	7" Dia	13"
Box Dimension (mm)	184x187x47	343x343x64
Max qty per Box	9,000	30,000
Weight per unit (gm)	0.0055	0.0055
Weight per Reel (kg)	0.1140	0.3960
Note/Comments		



F63TNR Label sample

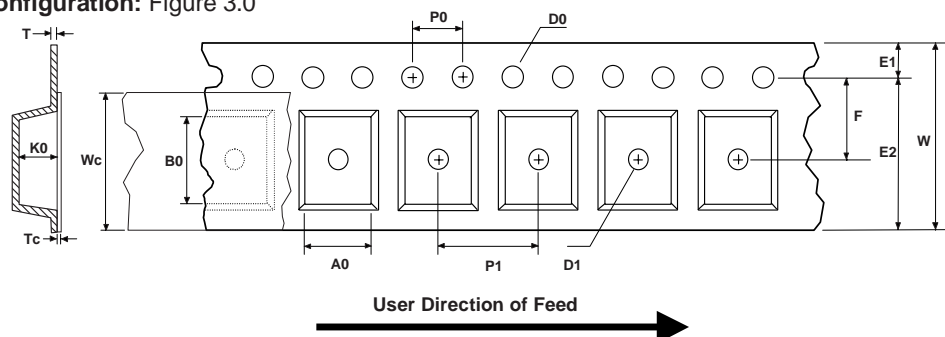


SC70-6 Tape Leader and Trailer Configuration: Figure 2.0



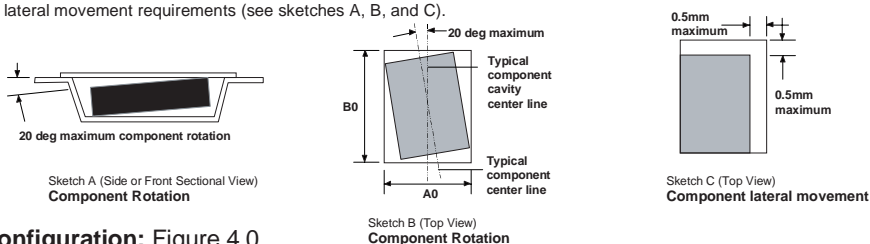
SC70-6 Tape and Reel Data and Package Dimensions, continued

SC70-6 Embossed Carrier Tape Configuration: Figure 3.0

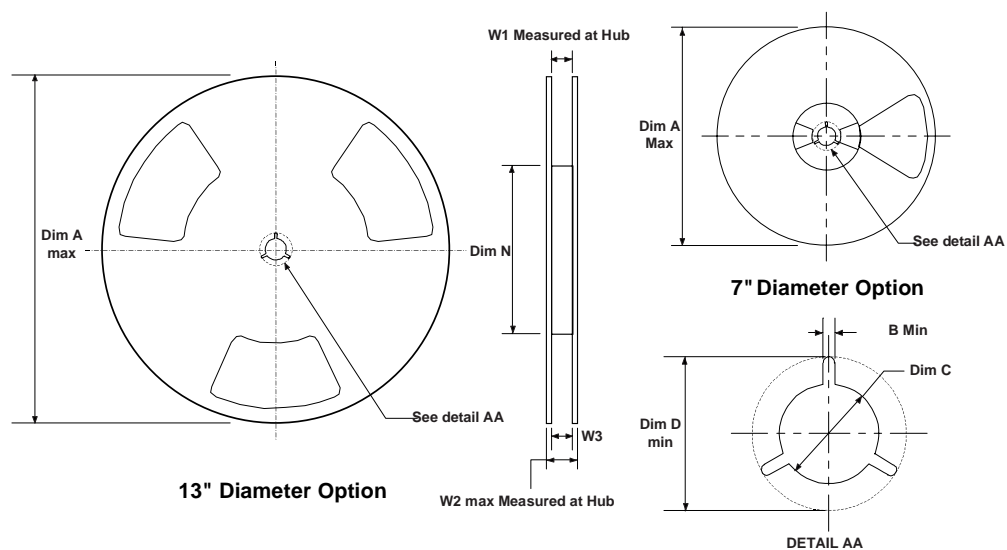


Dimensions are in millimeter														
Pkg type	A0	B0	W	D0	D1	E1	E2	F	P1	P0	K0	T	Wc	Tc
SC70-6 (8mm)	2.24 +/-0.10	2.34 +/-0.10	8.0 +/-0.3	1.55 +/-0.05	1.125 +/-0.125	1.75 +/-0.10	6.25 min	3.50 +/-0.05	4.0 +/-0.1	4.0 +/-0.1	1.20 +/-0.10	0.255 +/-0.150	5.2 +/-0.3	0.06 +/-0.02

Notes: A0, B0, and K0 dimensions are determined with respect to the EIA/Jedec RS-481 rotational and lateral movement requirements (see sketches A, B, and C).



SC70-6 Reel Configuration: Figure 4.0



Dimensions are in inches and millimeters									
Tape Size	Reel Option	Dim A	Dim B	Dim C	Dim D	Dim N	Dim W1	Dim W2	Dim W3 (LSL-USL)
8mm	7" Dia	7.00 177.8	0.059 1.5	0.512 +0.020/-0.008 13 +0.5/-0.2	0.795 20.2	2.165 55	0.331 +0.059/-0.000 8.4 +1.5/0	0.567 14.4	0.311 - 0.429 7.9 - 10.9
8mm	13" Dia	13.00 330	0.059 1.5	0.512 +0.020/-0.008 13 +0.5/-0.2	0.795 20.2	4.00 100	0.331 +0.059/-0.000 8.4 +1.5/0	0.567 14.4	0.311 - 0.429 7.9 - 10.9

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